

HAT2165H

Silicon N Channel Power MOS FET Power Switching

REJ03G0004-0600 Rev.6.00 Sep 20, 2005

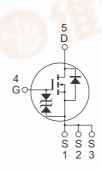
Features

- High speed switching
- Capable of 7 V gate drive
- Low drive current
- High density mounting
- Low on-resistance $R_{DS(on)} = 2.5 \text{ m}\Omega \text{ typ. (at } V_{GS} = 10 \text{ V})$

Outline

RENESAS Package code: PTZZ0005DA-A) (Package name: LFPAK)





1, 2, 3 Source 4 Gate 5 Drain

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	55	Α
Drain peak current	I _{D(pulse)} Note1	220	A
Body-drain diode reverse drain current	I _{DR}	55	A. COM
Avalanche current	I _{AP} Note 2	30	A
Avalanche energy	E _{AR} Note 2	90	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	−55 to +150 °C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

- 2. Value at Tch = 25°C, Rg \geq 50 Ω
- 3. Tc = 25°C



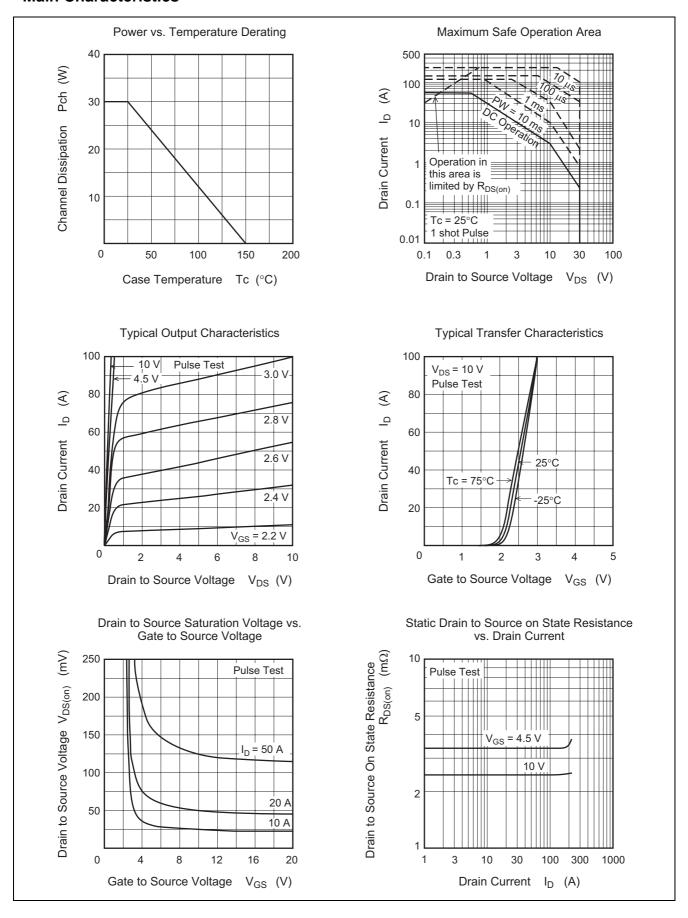
Electrical Characteristics

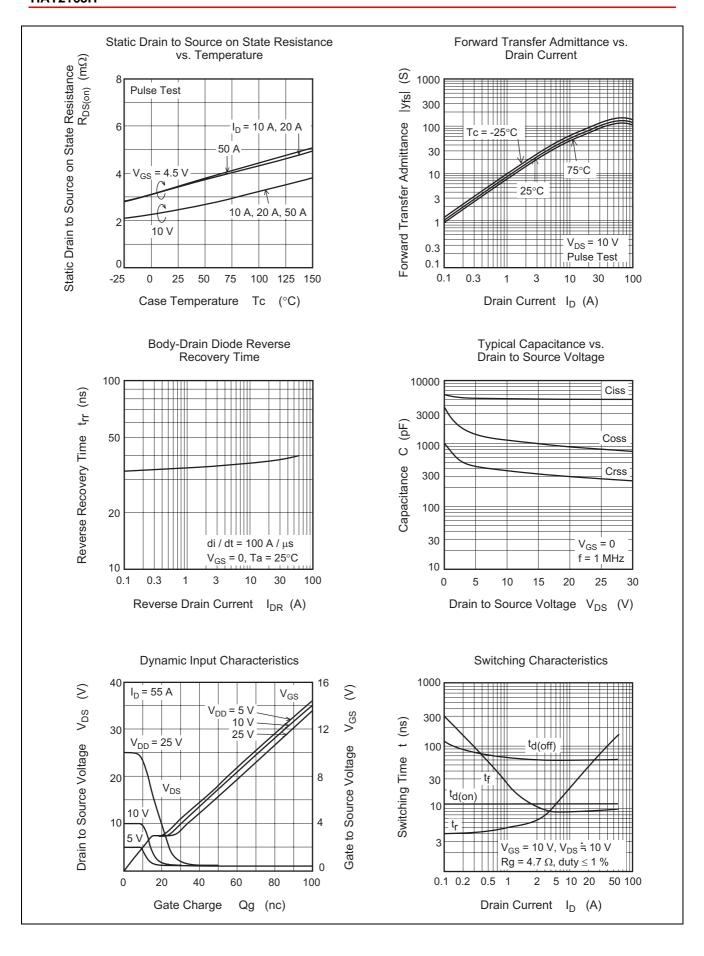
 $(Ta = 25^{\circ}C)$

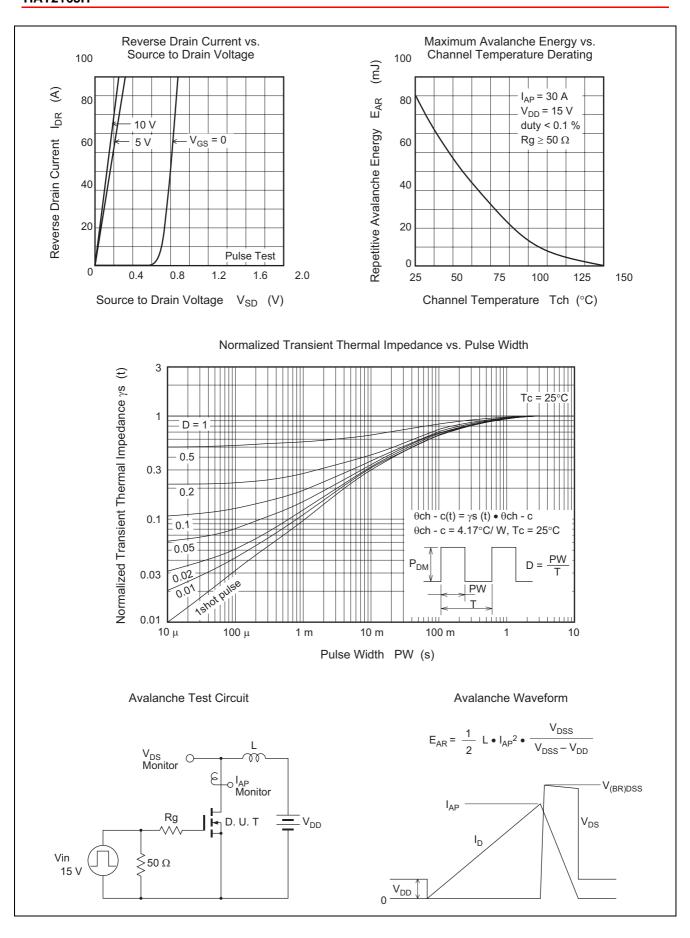
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	_	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state	R _{DS(on)}	_	2.5	3.3	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$
resistance	R _{DS(on)}	_	3.4	5.3	mΩ	$I_D = 27.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	60	100		S	$I_D = 27.5 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Input capacitance	Ciss	_	5180		pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	1200		pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	380		pF	
Gate Resistance	Rg	_	0.5		Ω	
Total gate charge	Qg	_	33	_	nC	$V_{DD} = 10 \text{ V}, V_{GS} = 4.5 \text{ V},$ $I_{D} = 55 \text{ A}$
Gate to source charge	Qgs	_	15	_	nC	
Gate to drain charge	Qgd	_	7.1	_	nC	
Turn-on delay time	t _{d(on)}	_	13	_	ns	$\begin{aligned} V_{GS} &= 10 \text{ V, } I_D = 27.5 \text{ A,} \\ V_{DD} &\cong 10 \text{ V, } R_L = 0.36 \Omega, \\ Rg &= 4.7 \Omega \end{aligned}$
Rise time	t _r	_	65	_	ns	
Turn-off delay time	t _{d(off)}	_	60	_	ns	
Fall time	t _f	_	9.5	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.81	1.06	V	IF = 55 A, V _{GS} = 0 ^{Note4}
Body-drain diode reverse recovery	t _{rr}	_	40	_	ns	IF = 55 A, V _{GS} = 0
time						$di_F/dt = 100 \text{ A/} \mu\text{s}$

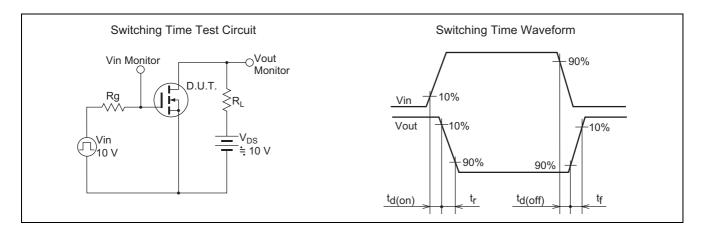
Notes: 4. Pulse test

Main Characteristics

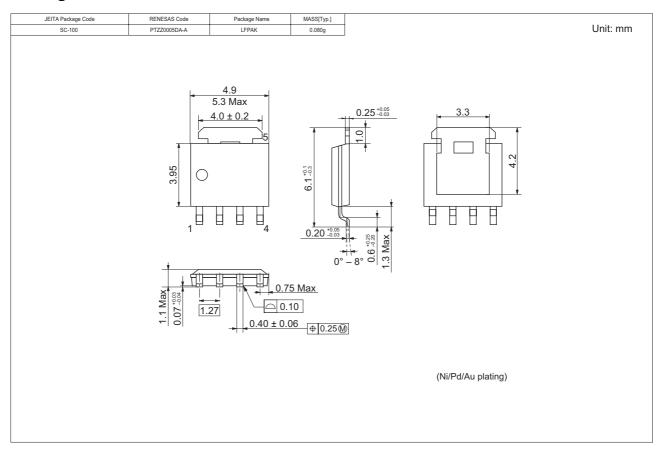








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2165H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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